Electronic Patent Application Fee Transmittal							
Application Number:	10	10607782					
Filing Date:	27	27-Jun-2003					
Title of Invention:	Liquid solder thermal interface material contained within a cold-formed barrier and methods of making same						
First Named Inventor:	Sabina J. Houle						
Filer:	Joseph P. Mehrle/Anne Richards						
Attorney Docket Number:	884.860US1						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Notice of appeal		1401	1	500	500		
Post-Allowance-and-Post-Issuance:			,				
Extension of Time							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$) 5			500